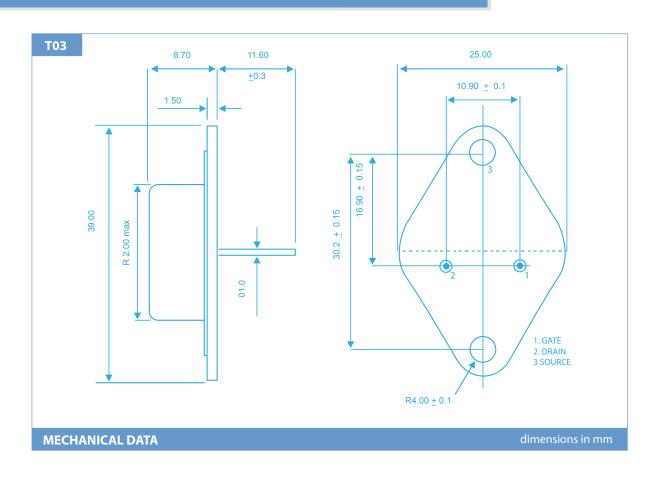


HIGH POWER 250W HIGH QUALITY AUDIO AMPLIFIER APPLICATIONS

P CHANNEL LATERAL MOSFET



ABSOLUTE (T _C = 25°C un	ECF20P20	
V_{DSX}	Drain – Source Voltage	200V
V_{GSS}	Gate – Source Voltage	±14V
I_{D}	Continuous Drain Current	16A
$I_{D(PK)}$	Body Drain Diode	16A
P_{D}	Total Power Dissipation @ (T case = 25°C)	250W
T_{stg}	Storage Temperature Range	-55 to 150°C
T_{j}	Maximum Operating Junction Temperature	150°C
RθJC	Thermal Resistance Junction - case	0.5°C/W

Exicon products are available at www.profusionplc.com



(T_C= 25°C unless otherwise stated) STATIC CHARACTERISTICS

Characteristic		Test Conditions		MIN	TYP	MAX	UNIT
BV _{DSX}	Drain – Source Breakdown Voltage	ID = 10mA	ECF20P20	200			V
BV_{GSS}	Gate – Source Breakdown Voltage	VDS = 0	IG= <u>+</u> 100uA	<u>+</u> 14			V
$V_{GS(OFF)}$	Gate - Source Cut-Off Voltage	VDS = 10V	ID = 100mA	0.10		1.5	V
V _{DS(SAT)} *	Drain - Source Saturation Voltage	VGD = 0	ID = 16A			12	V
I _{DSX}	Drain - Source Cut - Off Current	VGS = -10V	VDS =200V			10	mA
Yfs*	Forward Transfer Admittance	VDS = 10V	ID = 3A	1.4		4	S

DYNAMIC CHARACTERISTICS (T_C= 25°C unless otherwise stated)

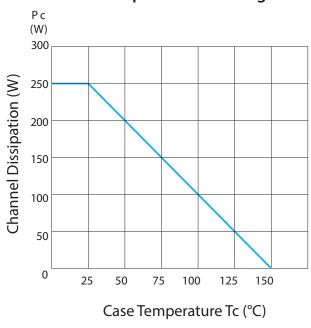
Characteri	stic	Test Conditions	N-Channel	P-Channel	UNIT	
C_{iss}	Input Capacitance		950	1900	pF	
C _{oss}	Output Capacitance	VDS= 10V f = 1MHz	550	900		
C_{rss}	Reverse Transfer Capacitance		20	60		
t _{on}	Turn-on Time	VDS= 20V	160	150	nc	
t _{off}	Turn-off Time	ID = 7A	80	110	ns	

^{*} Pulse Test: Pulse Width = $300\mu s$, Duty Cycle $\leq 2\%$

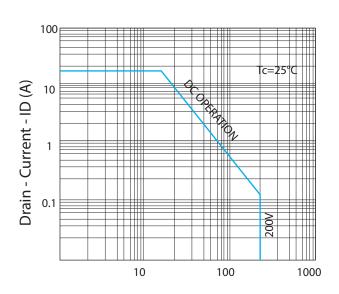


Typical Characteristics for 250W devices

Power vs. Temperature Derating

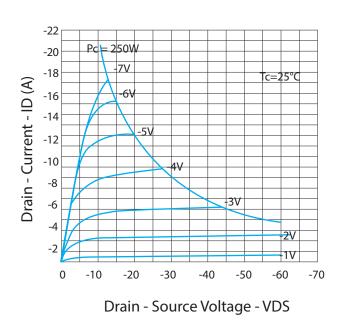


Maximum Safe Operating Area



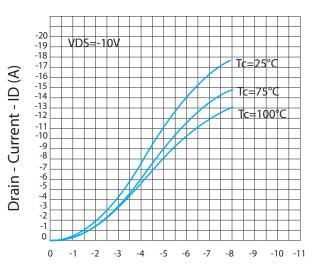
Drain - Source Voltage - VDS

Typical Output (P-Channel)



www.exicon.info

Typical Transfer Characteristics (P-Channel)



Drain - Source Voltage - VGS



Typical Characteristics for 250W devices (cont.)

Forward Transfer Admittance (P-Channel)

